

# The PERCIVAL soft X-ray Detector

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DESY – Photon Science Detectors  
TREDI 2019 – Trento, Italy

**HELMHOLTZ** RESEARCH FOR  
GRAND CHALLENGES



**Elettra**  
Sincrotrone Trieste

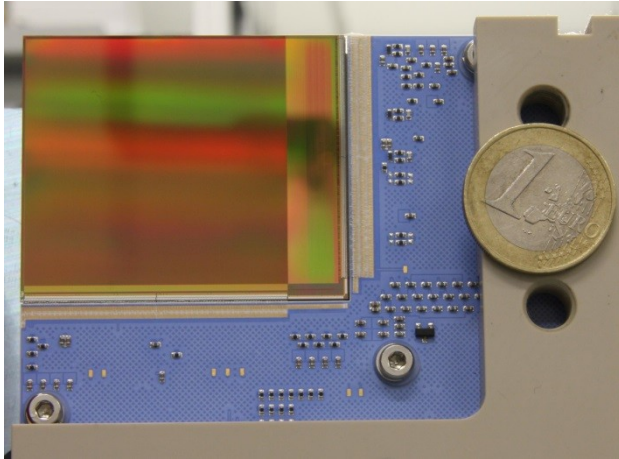
**CFEL**  
SCIENCE



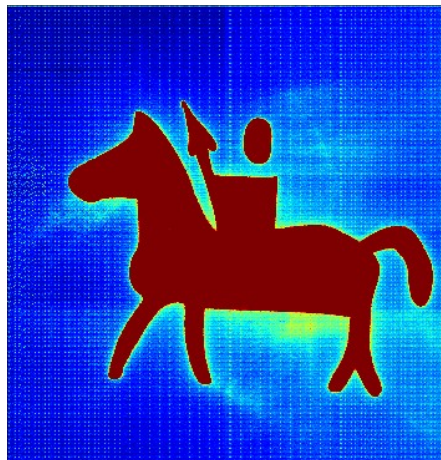
# PERCIVAL



## in a nutshell



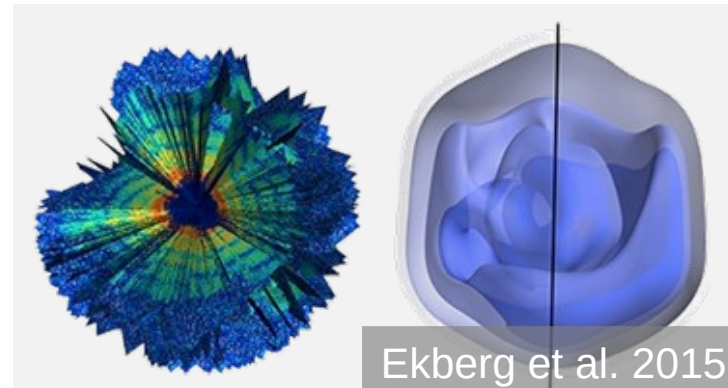
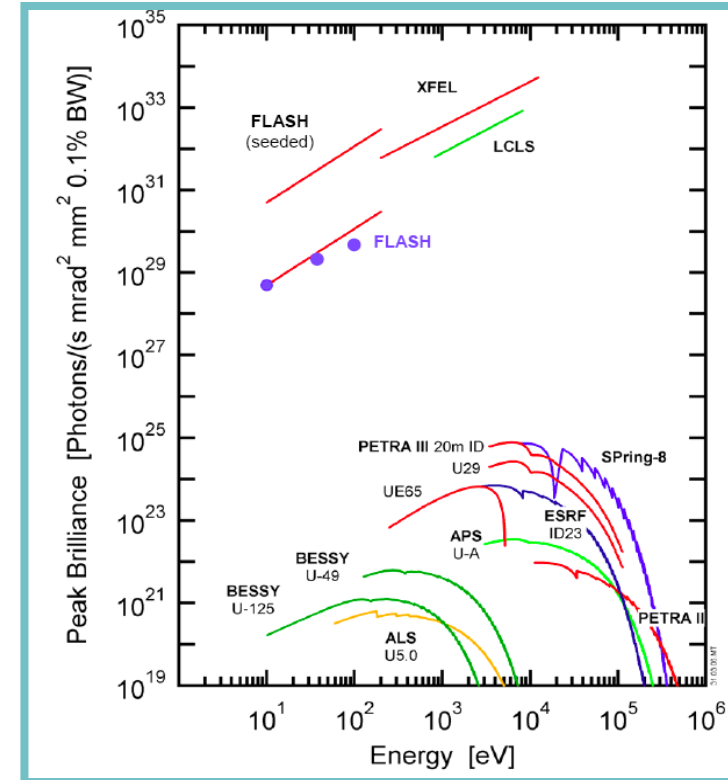
|                                |                                                                 |
|--------------------------------|-----------------------------------------------------------------|
| <b>Energy Range</b>            | Primary: 250eV – 1keV<br>Extended: 100eV - 3keV                 |
| <b>Quantum Efficiency</b>      | > 85%, uniform over pixel                                       |
| <b>Pixel Size</b>              | 27 $\mu\text{m}^2$                                              |
| <b>Active Area</b>             | 1440 x 1484 pixels / 4 x 4 $\text{cm}^2$                        |
| <b>Frame Rate</b>              | 120 / 300 Hz                                                    |
| <b>“Full Well”</b>             | $> 10^7$ e-                                                     |
| <b>Resulting Dynamic Range</b> | $10^5$ photons (@ 250eV)                                        |
| <b>Sensor Output</b>           | Digital, LVDS                                                   |
| <b>Buttability</b>             | 2-side (adjacent edges)                                         |
| <b>Exposure Mode</b>           | FEL: all photons in $< 300$ fs<br>Synchrotron: Quasi-continuous |



# Science Motivation

## Watching biomolecules in action ... and more

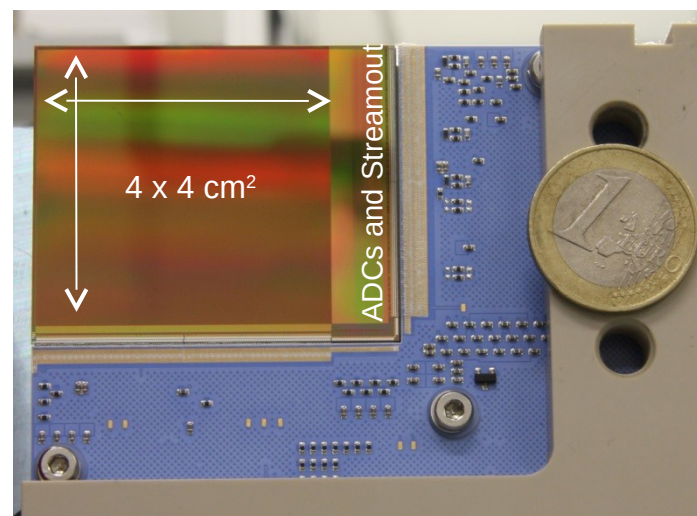
- Making optimal use of the brilliance of today's photon sources requires
  - Single-shot imagers with suitable frame rates
  - Very large dynamic range
    - single-photon discrimination to
    - $10^4$  photons/pixel/frame and more
  - Millions of pixels with little/no dead area
- In the soft X-ray regime
  - Scientific interest e.g. biosystems, weakly scattering samples
  - Particular challenge: small signal requires very low noise
  - Particular challenge: sensor surface



# P2M Sensor

Designed by partner Rutherford Appleton Lab / STFC

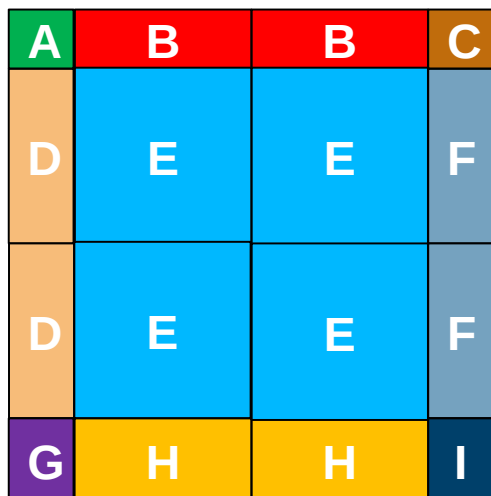
- CMOS imager (180nm technology)
- On-chip digitization (11520 ADCs)
- 3 auto-adjusting gain levels (per pixel, per frame, overflow)
- $1408 \times 1484$  pixels,  $27\mu\text{m} \times 27\mu\text{m}$
- $4 \times 4 \text{ cm}^2$  continuous imaging area (stitched sensor)
- Data rate at 300Hz frame rate is 20 Gbit/s, streamed out over 45 LVDS lines (240 MHz, double data rate)



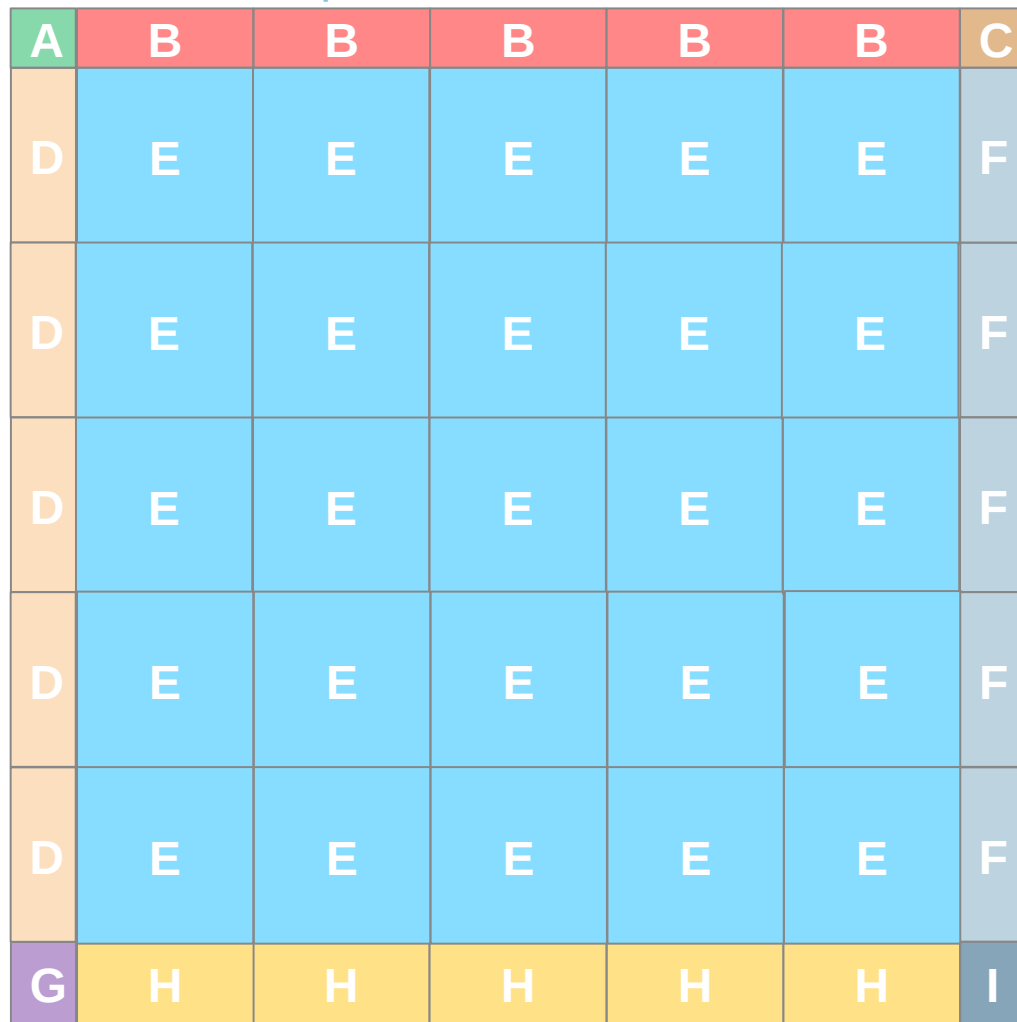
# P2M Sensor

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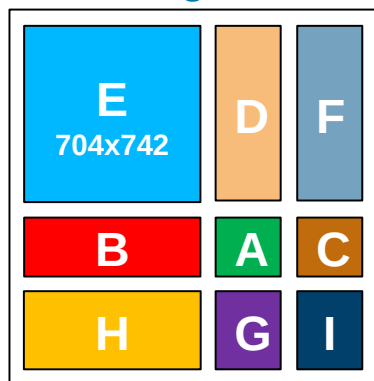
1408 x 1484 pixel P2M



3520 x 3710 pixel variant, P13M ~ 10x10cm<sup>2</sup>



stitching blocks

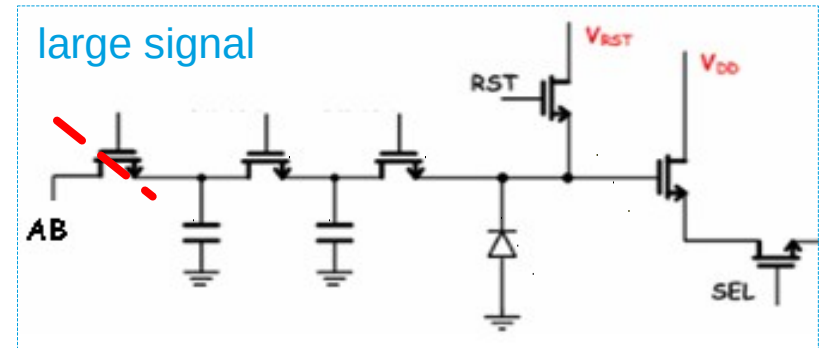
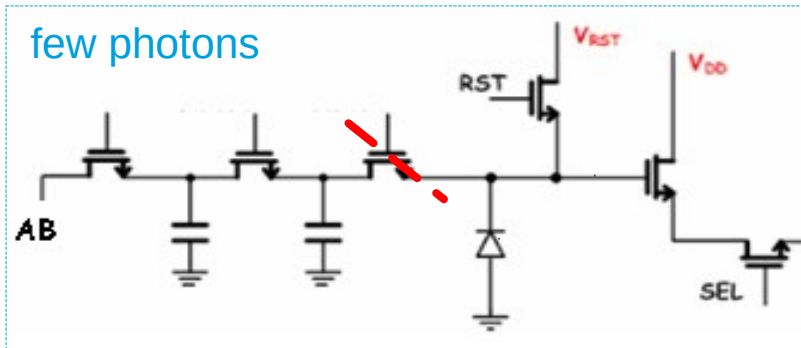
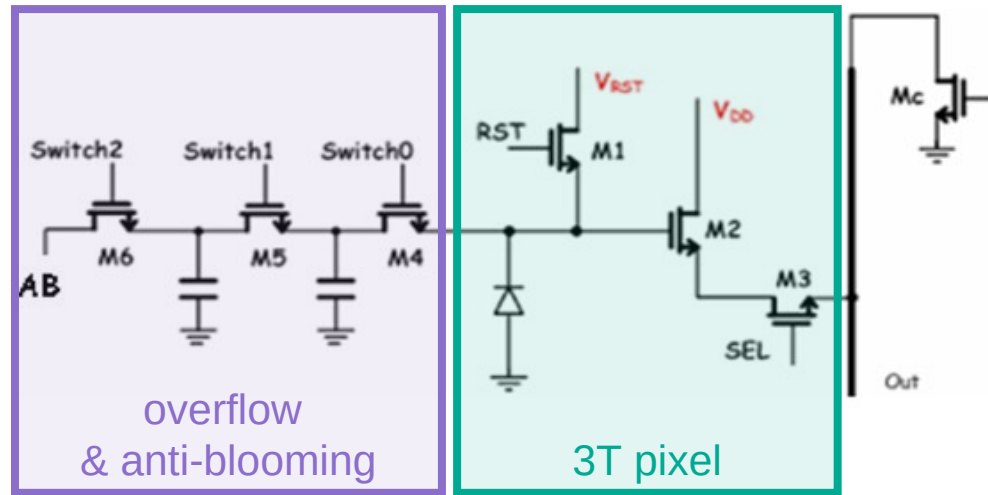


# P2M Sensor



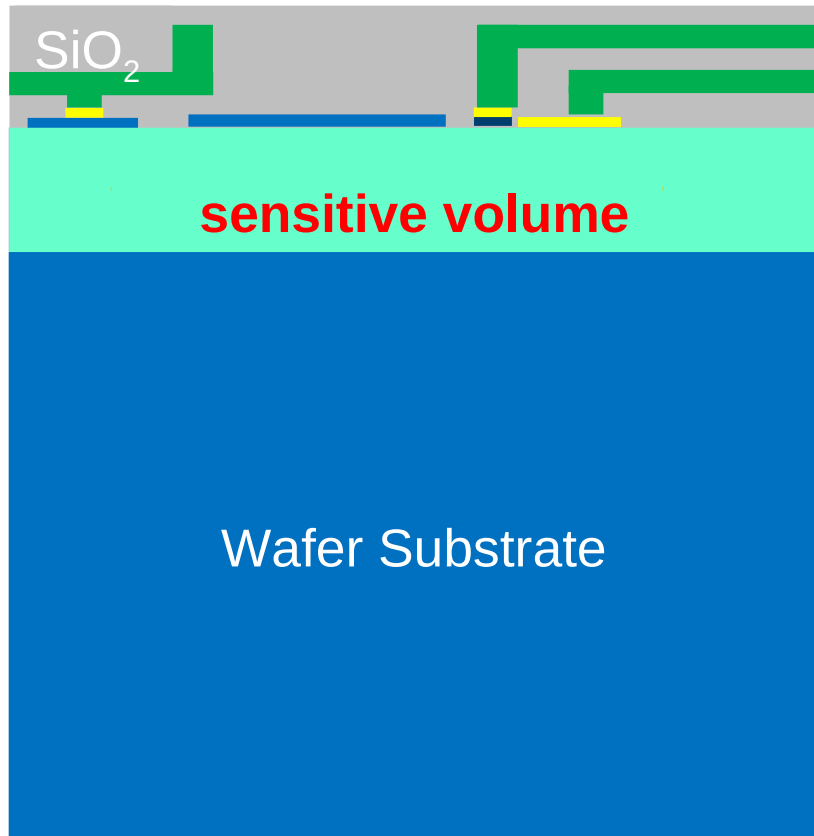
Designed by partner Rutherford Appleton Lab / STFC

- 3 auto-adjusting gain levels(per pixel, per frame, overflow)
- Readout sequentially tests all three overflow configurations for each pixel against threshold
- Only best candidate digitized & sent to DAQ



# Backside Illumination

How to enable soft X-rays to interact in the sensitive volume



~ 10  $\mu\text{m}$   $\text{SiO}_2$  & metals

~ 10  $\mu\text{m}$  epi Si

~ 700  $\mu\text{m}$  low-resistivity Si

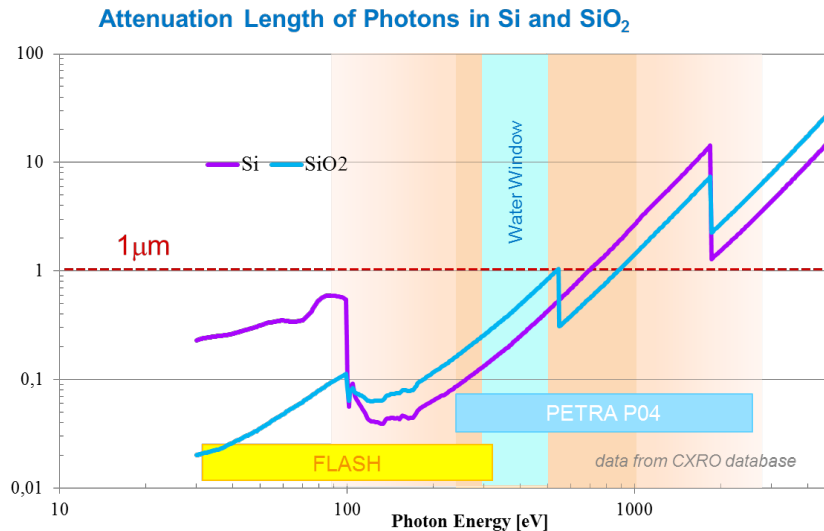
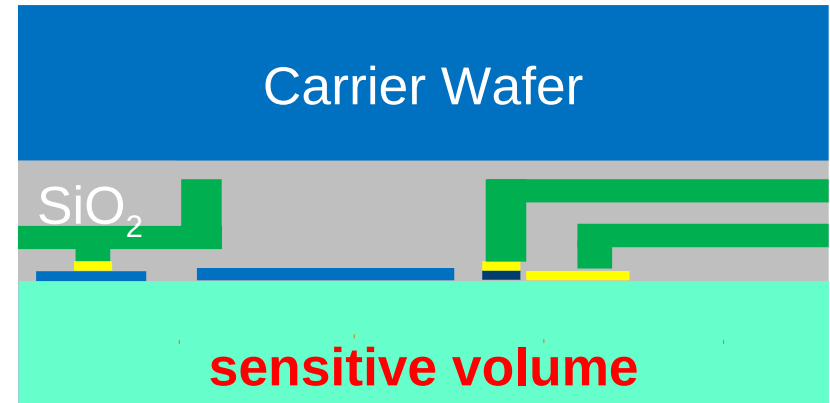
# Entrance Window Post-processing



## How to enable soft X-rays to interact in the sensitive volume

High sensitivity to low-energy radiation requires:

- Absence of passive material and traps
- Optimized field geometry at sensor surface



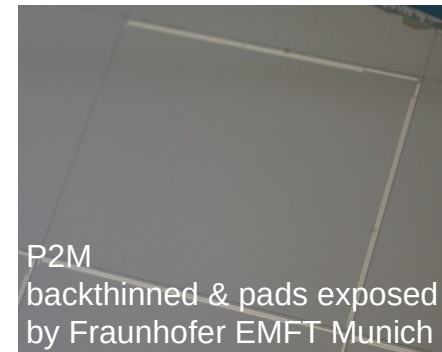
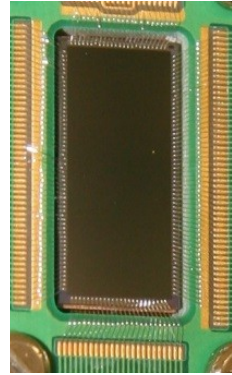
e.g. 50 nm of SiO<sub>2</sub>:  
loss of 25% of 250 eV photons

**High-quality backside processing is crucial!**



# Post-Processing for PERCIVAL








- Prototype Sensor post-processed by NASA's JPL "delta-doping"
  - Pioneered ultra-thin entrance windows (few nm)
  - Bureaucratic difficulties mainly make access difficult & time-consuming
  - TS sensors processed by JPL give nice soft X-ray performance
- P2M sensor post-processing
  - JPL remains a key partner and will process wafers
  - Exploring alternate routes to "good" post-processing (for some applications 10s of nm are acceptable)
    - EMFT currently a partner in tests (bonding, thinning, pad exposure)
  - Some routes to thicker dopant layers (10s to 100s of nm) exist, not tried yet
  - Easier-to-access MBE-based post-processing capable of processing both wafers and single (prototype) sensors direly needed

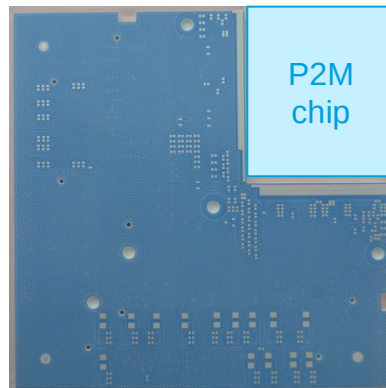
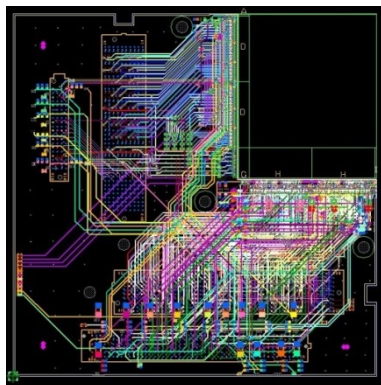
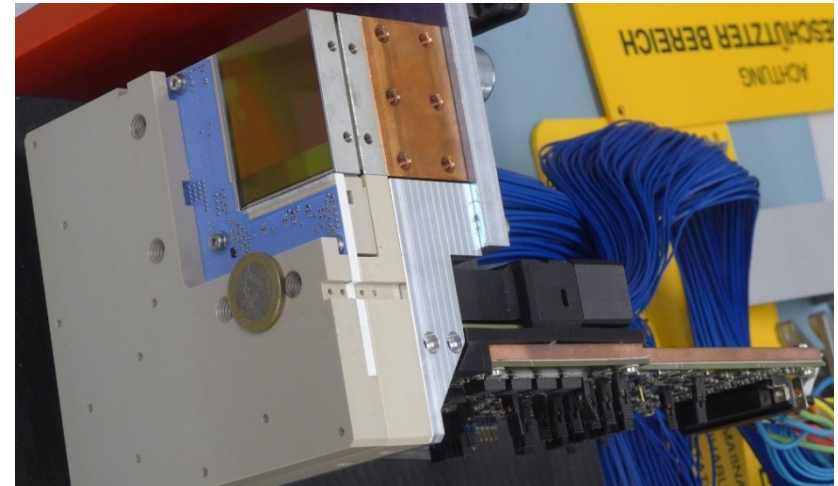


# P2M System

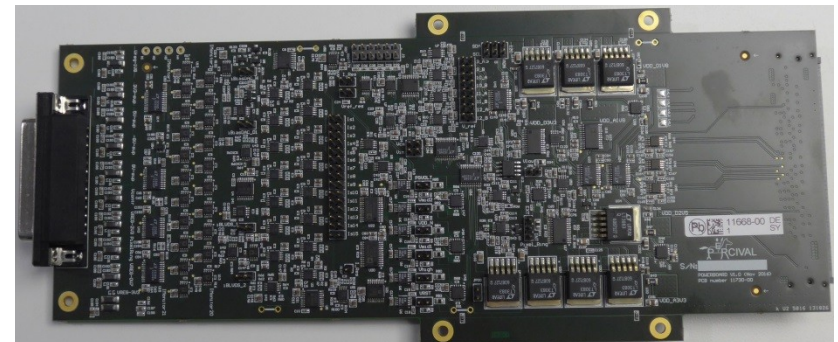


Currently undergoing benchtop tests in front-illuminated configuration

- In-vacuum detector head 
  - sensor 
  - Includes sensor biasing board 
  - Several hundred LVDS control & data lines, are (re)distributed here 
  - Sensor will be cooled to  $\sim -30^{\circ}\text{C}$
  - 2-side buttable 
  - movable 



LTCC routing & actual board






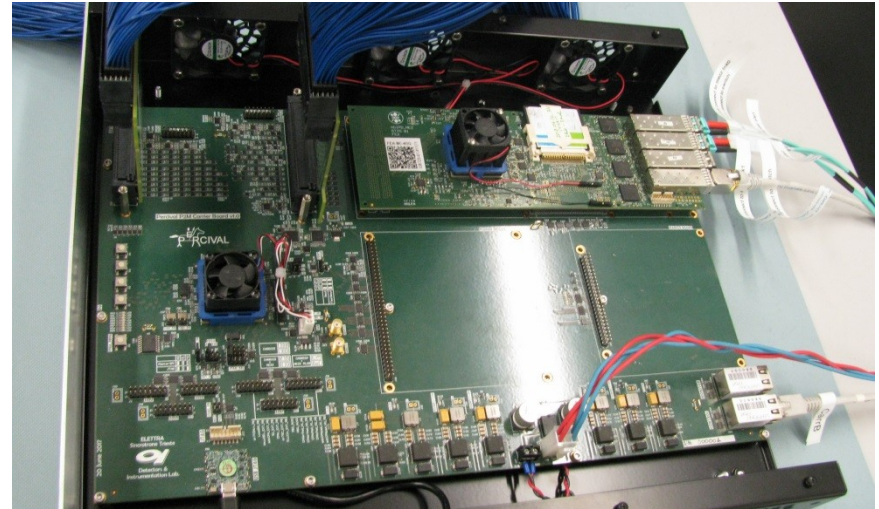
PowerBoard for sensor supply & biasing

# P2M System

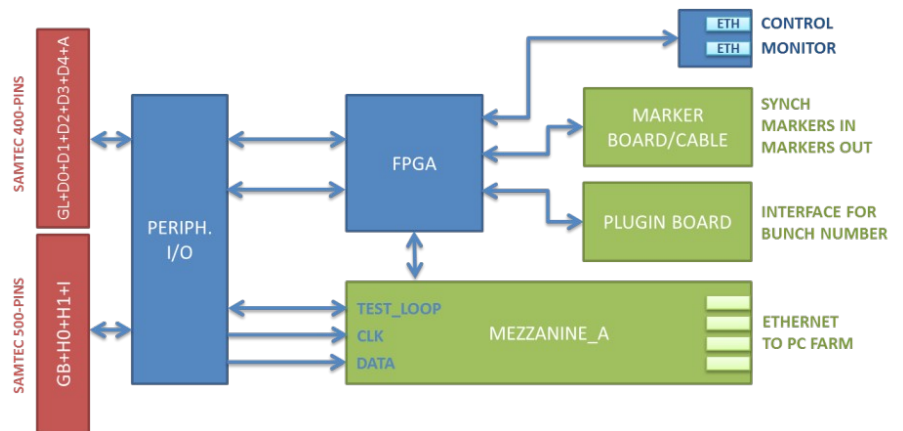


Currently undergoing benchtop tests in front-illuminated configuration

- Carrier board hosts 
- FPGA running finite state machine 
- Mezzanine board (also AGIPD, Lambda)  reordering data for easier processing streaming out 20 Gbit/s data
- Interface to slow control, facility information, trigger




Mezzanine for data streamout shared by AGIPD, LAMBDA, and Percival

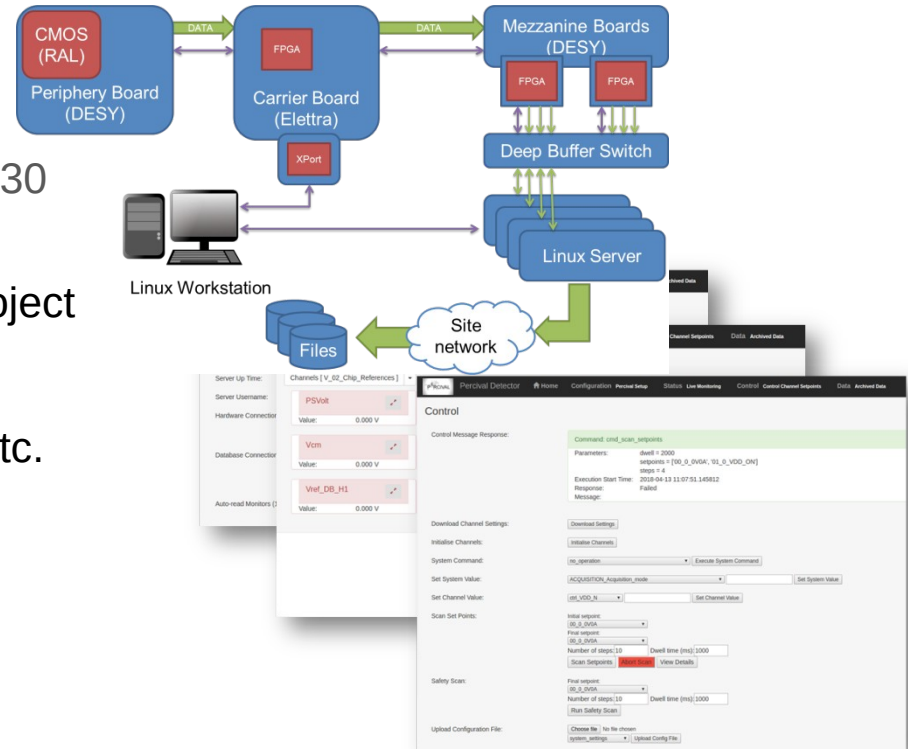


# P2M System



Currently undergoing benchtop tests in front-illuminated configuration

- Control & DAQ 
  - 20 Gbit/s from one sensor (reading full images: 300 Hz, 2M pixels, 30 bit/pixel incl. CDS)
  - Virtual hdf5 developed in part for this project
  - Python interface & Odin GUI interface
  - API for link to Tango, DOOCs, EPICS, etc.

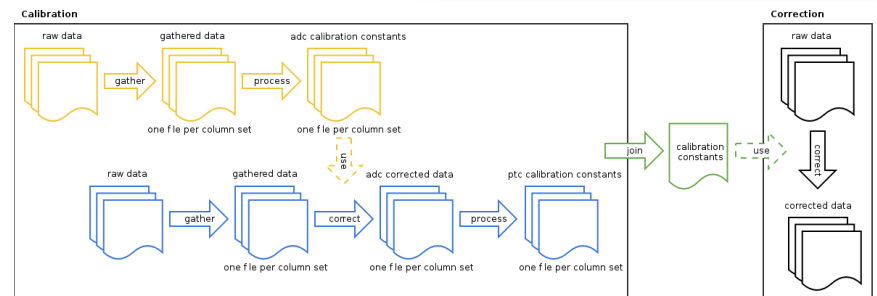


- Software Framework for Characterization



- Data validation
- Calibration constants
- Sensor characterization

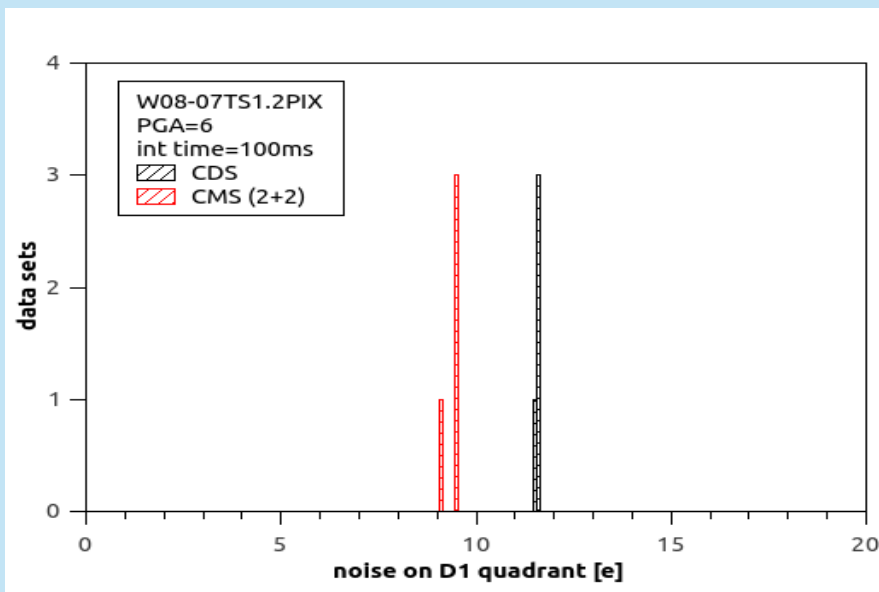
- Testing



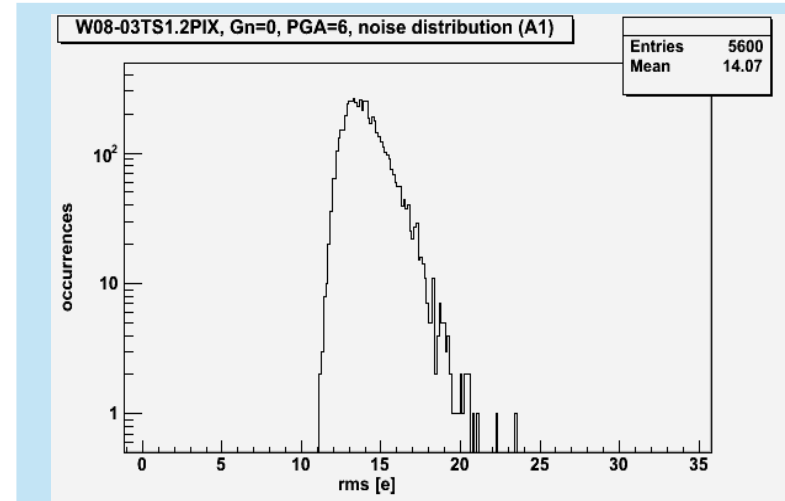
# Prototype Performance - Noise

## Noise

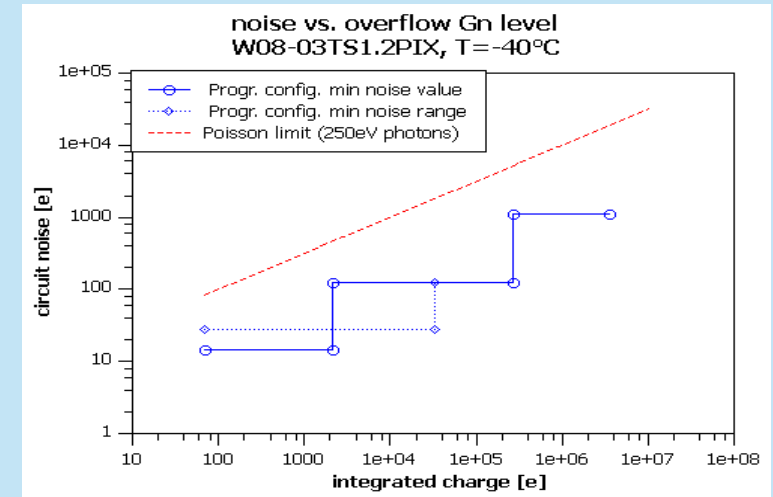
- reasonably low parameter dispersion between different samples (and wafers)
- Noise below Poisson limit
- preliminary tests indicate  $\sim 10 e^-$  rms reachable by multiple sampling



Multiple Sample Trial: Proof of principle.



Dispersion of pixel noise values (TS1.2)

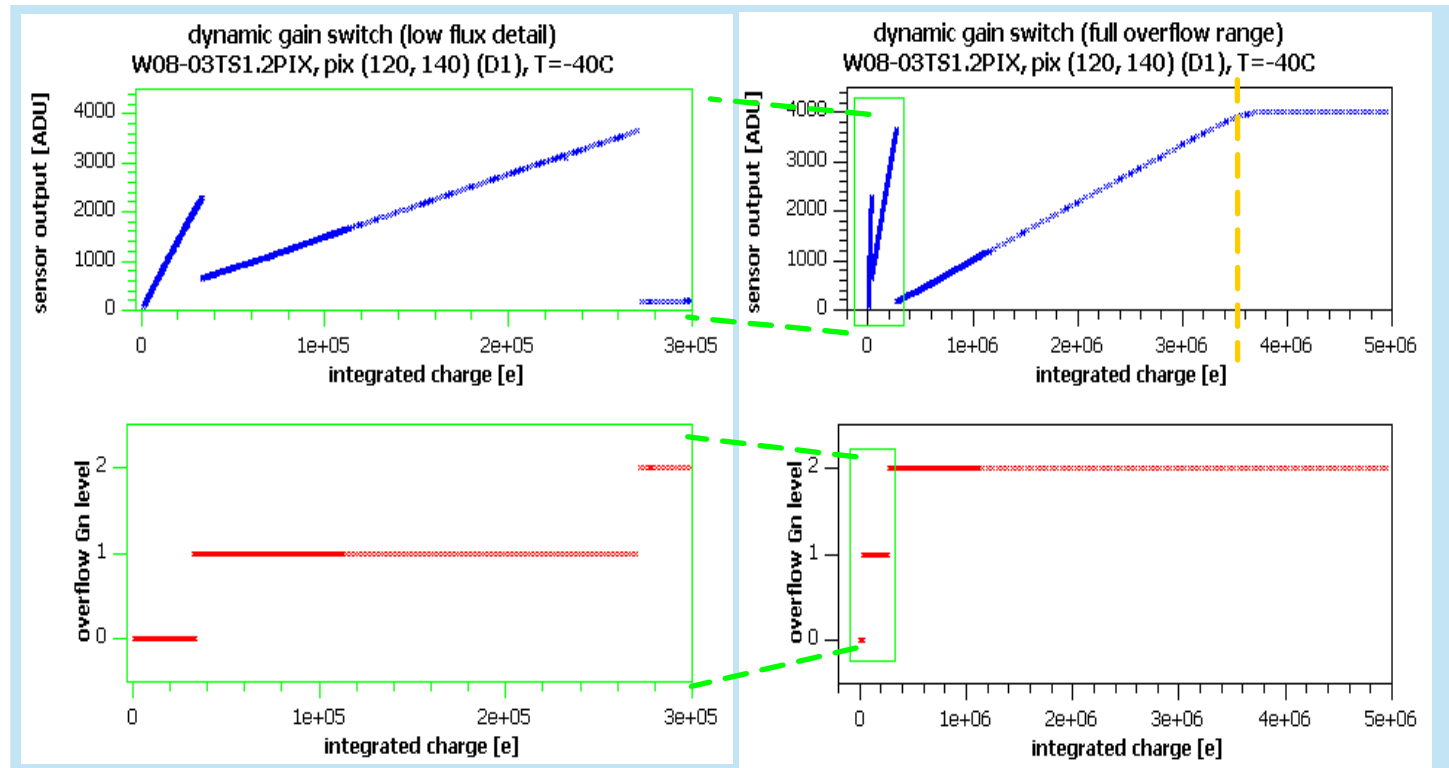


Noise well below Poisson shot noise at all times

# Prototype Performance

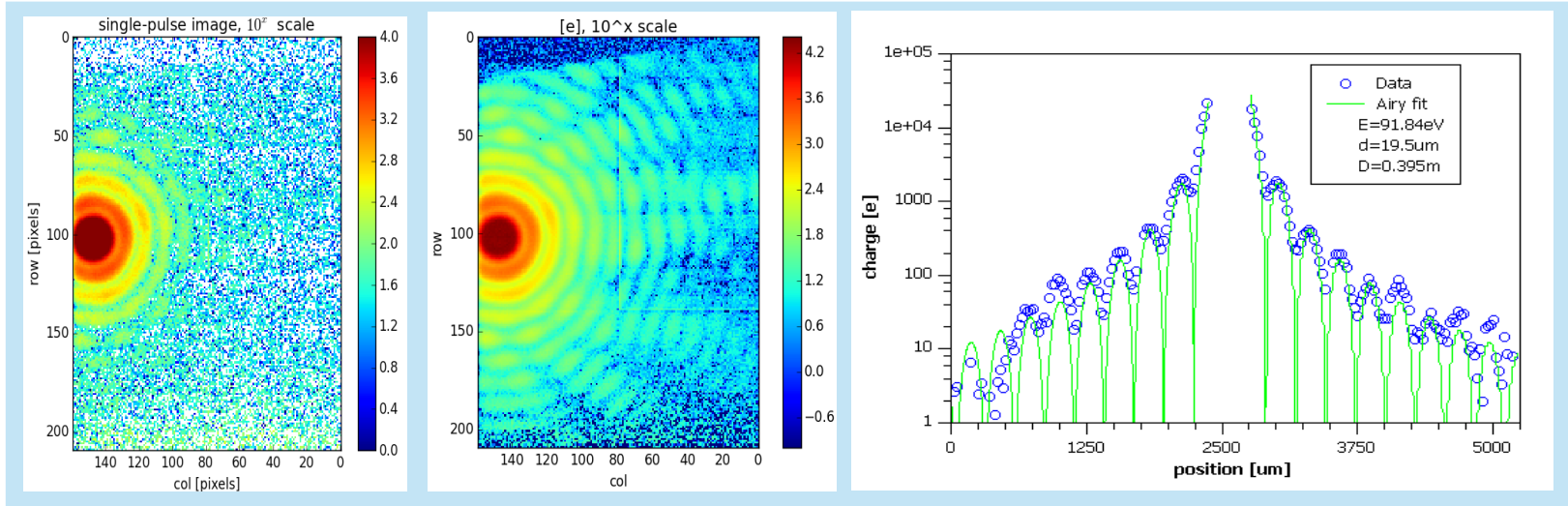
## Gains

- Automatic gain adjustment works
- 3 gains accessible via overflow switch architecture
- Dynamic range to 3.5 Me<sup>-</sup> i.e. 50k photons at 250eV

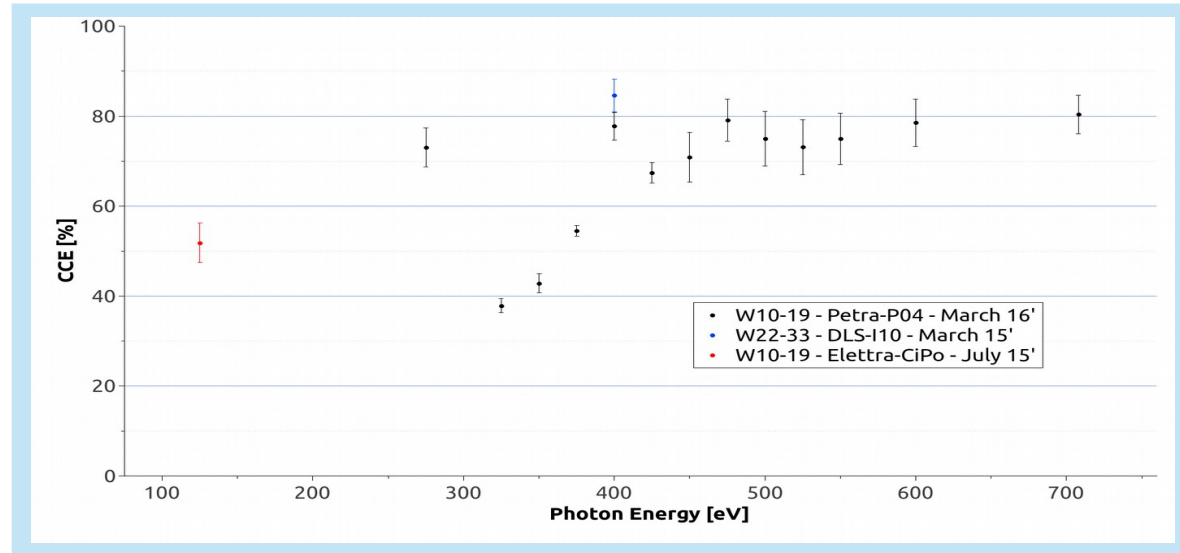


# Prototype Performance

## Backside-illuminated (BSI)

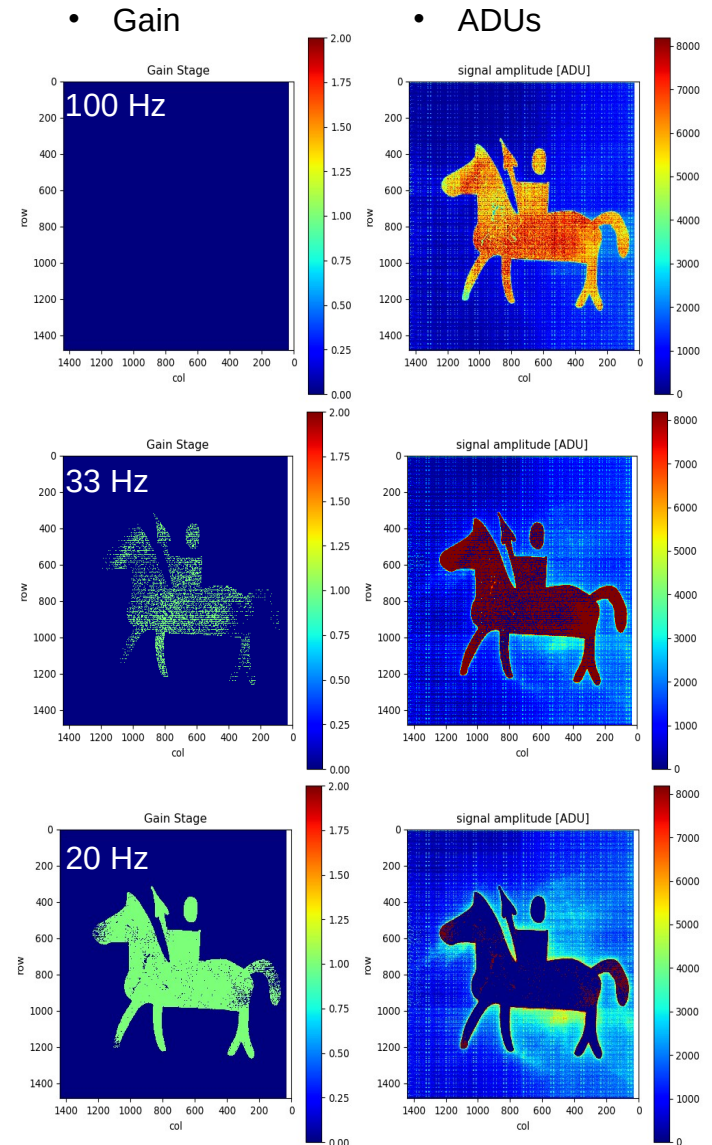
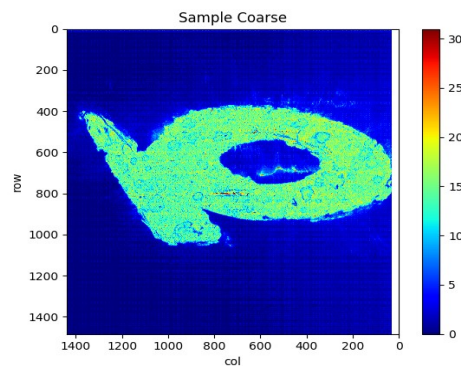


- Imaging at 92 eV, single-shot at FLASH
- Airy rings matching output
- CCE (lower limit to QE) measured at ~70% above 400 eV



# P2M Operation

- First light
- Visible light, room temperature
- 100Hz frame rate (stream-out speed of full acquisition system still ramping up)
- Automatic gain switching works
- Deployment. Two more system working and providing, last one at Elettra: 150Hz

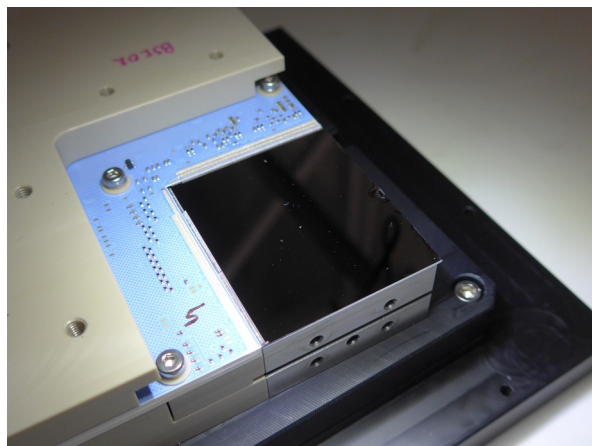
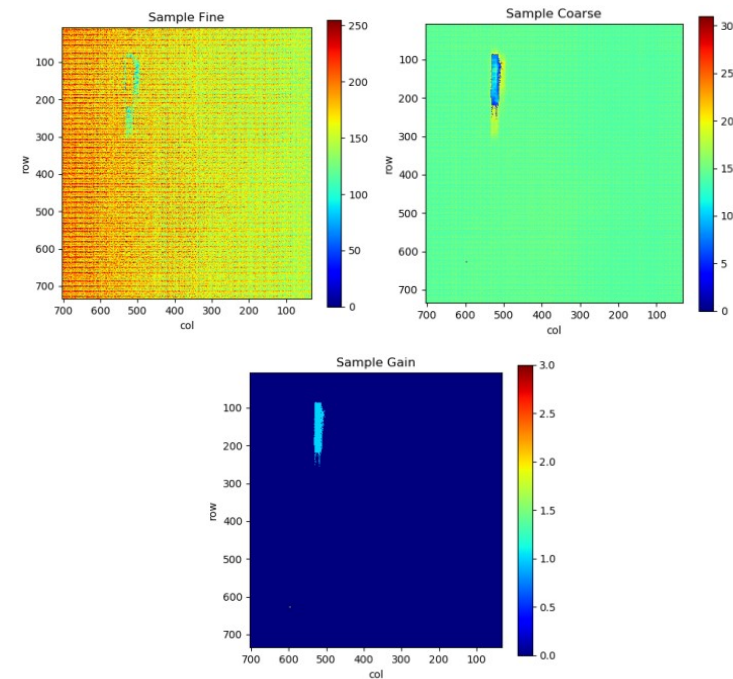




# Project Status & Outlook

## P2M FSI undergoing bench-top testing & BSI

- P2M system operates, saw first light and demonstrated auto gain switching in response to illumination
- P2M system obtained first results at a beam-line in December (P04 @ Petra III). Detailed characterisation and data analysis ongoing
- Chip functionality at 300Hz frame rate demonstrated, full readout & system ramping up



- P2M backthinned sensor wirebonded and calibrated
- First BSI tests starting this Friday
- First delta-doped P2M BSI ~ July 2019

# Thanks to Percival Collaborators:

## P2M FSI undergoing benchtop testing

### DESY:

Cornelia Wunderer  
Alessandro Marras  
Steve Aplin  
Peter Goettlicher  
Frantisek Krivan  
Manuela Kuhn  
Sabine Lange  
Magdalena Niemann  
Frank Okrent  
Igor Shevyakov  
Sergej Smoljanin  
Manfred Zimmer  
Heinz Graafsma



### Diamond:

Alan Greer  
Tim Nicholls  
Ulrik Pedersen  
Nicola Tartoni



### PAL:

HyoJung Hyun  
KyungSook Kim  
Seungyu Rah



### Soleil & DESY:

Benjamin Boitrelle



### RAL:

Iain Sedgwick  
Ben Marsh  
Nicola Guerrini



### JPL:

April D. Jewell  
Todd J. Jones  
Michael E. Hoenk  
Shouleh Nikzad



### Elettra:

Giuseppe Cautero  
Dario Giuressi  
Giovanni Pinaroli  
Luigi Stebel  
Ralf Menk



### EMFT:

Andreas Drost  
Christof Landesberger  
Armin Klumpp

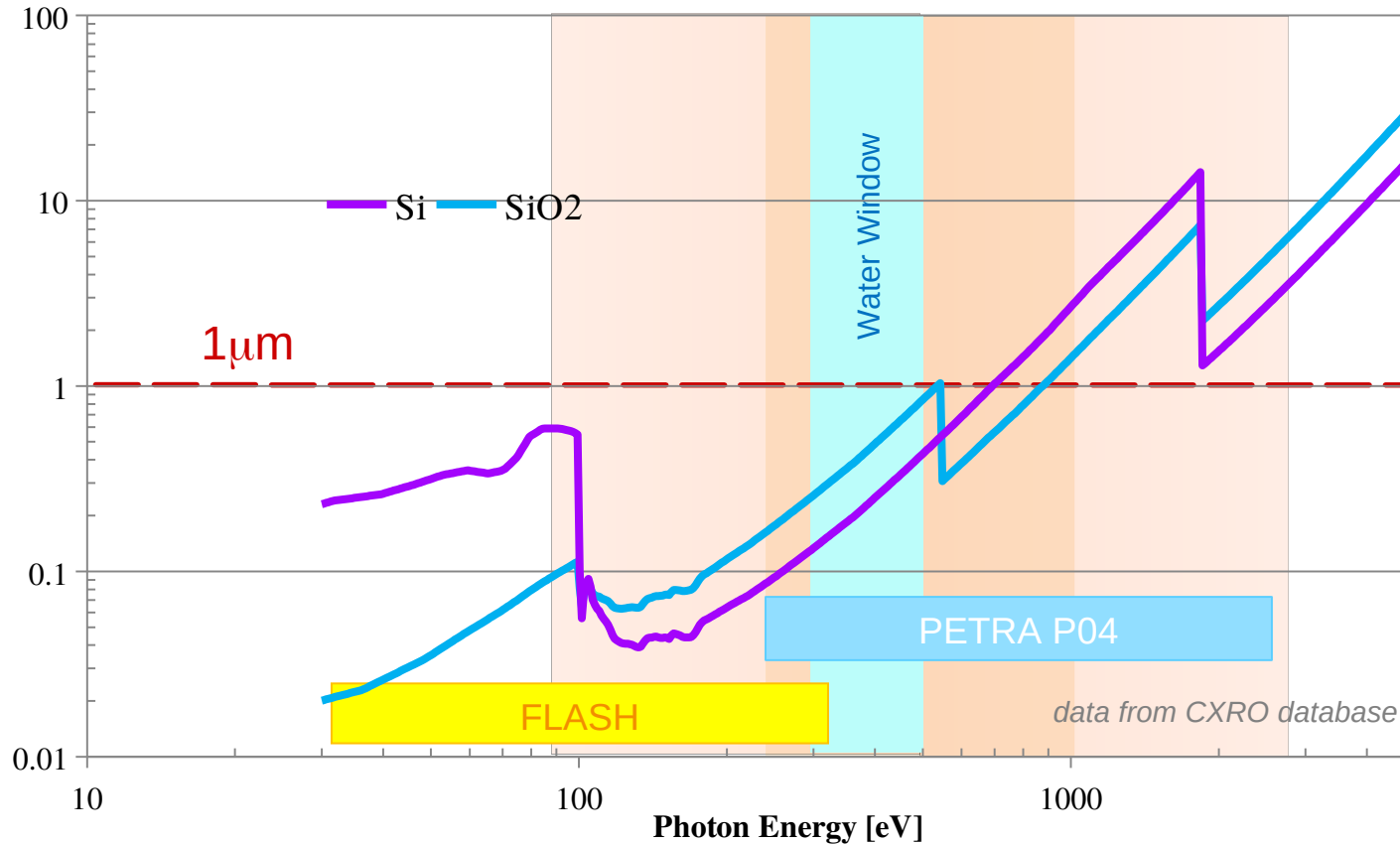


and beamline staff at Petra P04, Elettra TwinMic & CiPo, DLS I10, and Flash BL2 for their support

# Backup Slides

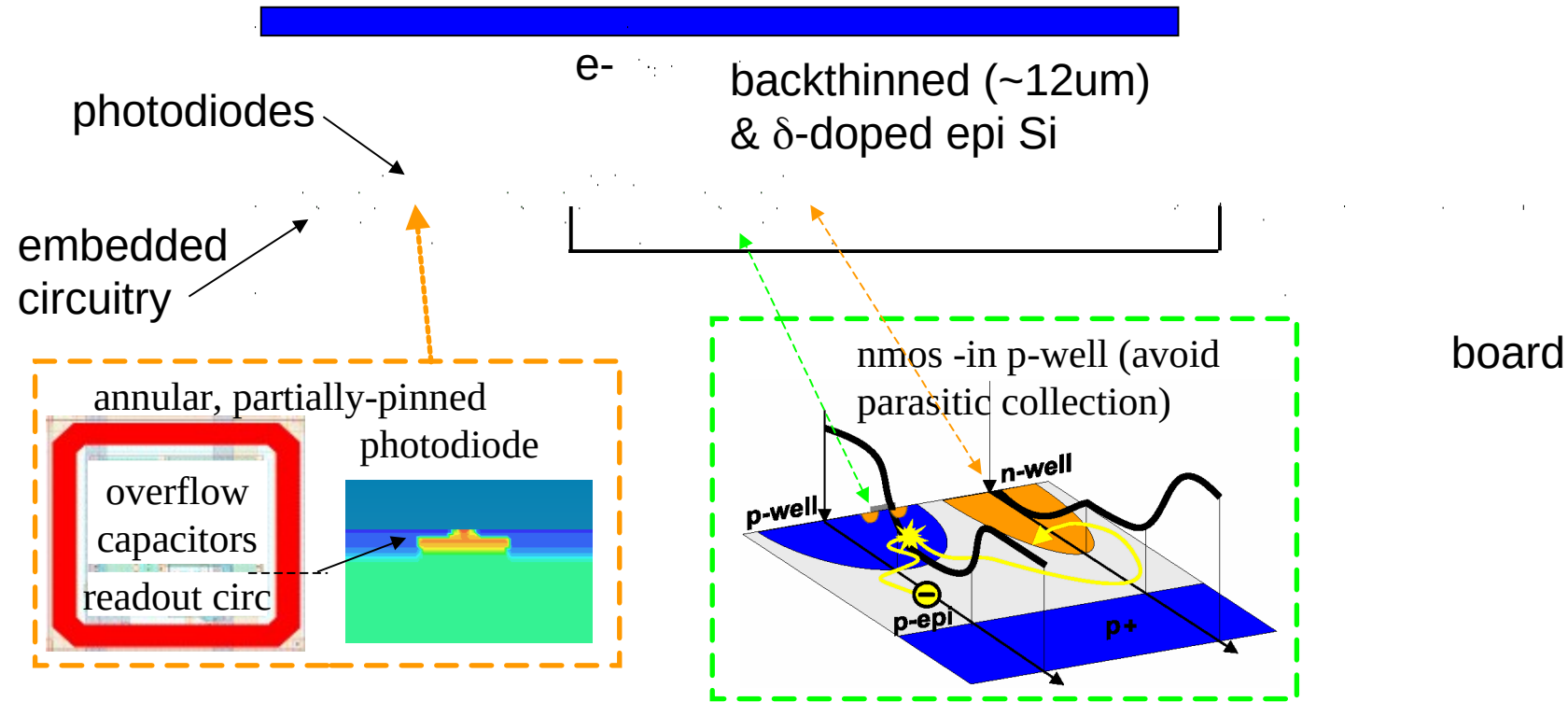


## Attenuation Length of Photons in Si and SiO<sub>2</sub>

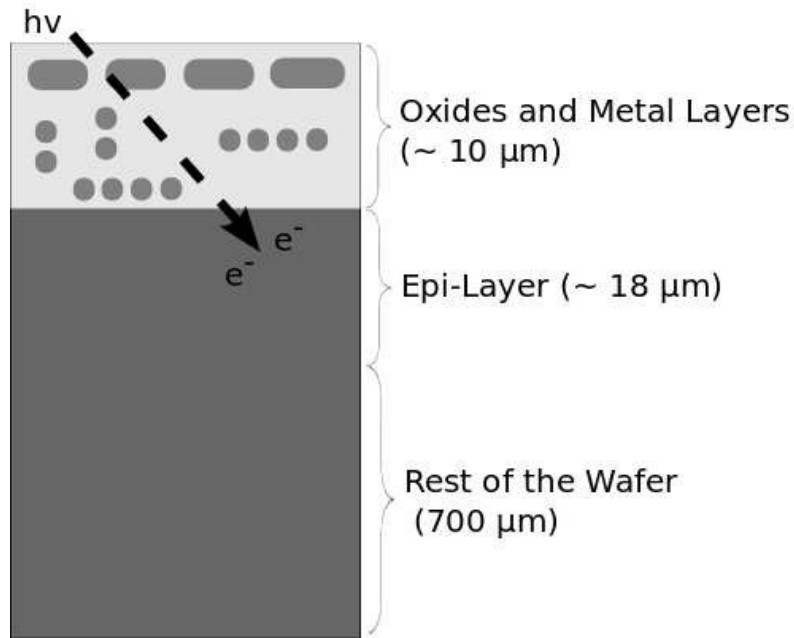


*At (very) soft X-ray energies, QE is limited by passive window thickness!*

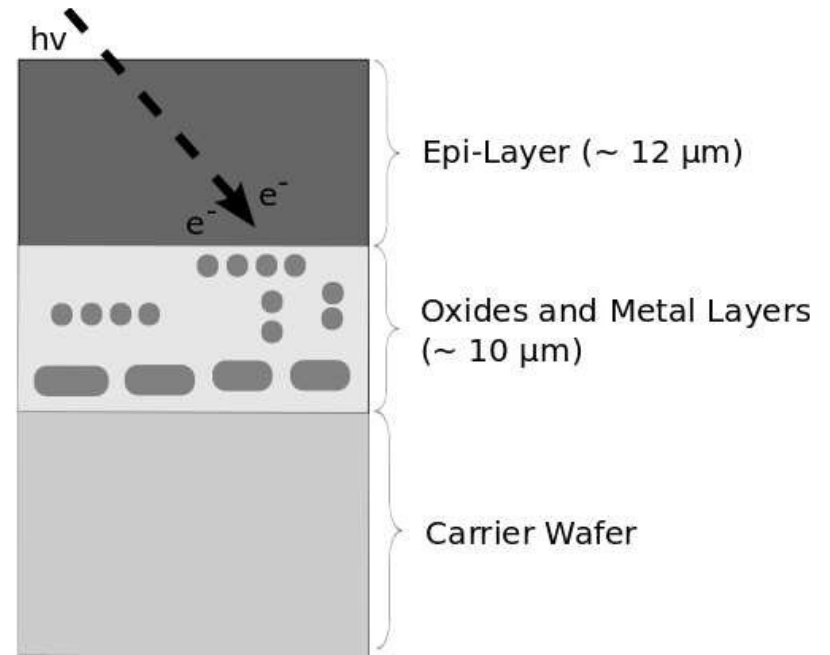
*e.g. 50 nm of SiO<sub>2</sub>: loss of 25% of 250 eV photons*



Monolithic: Collecting diodes & readout circuitry share the same substrate  
commercial standard 0.18um CMOS techn, over high-resistance thick epi  
Coupled to handling wafer, back-thinned, back-illuminated: 100% fill factor  
Back surface delta-doped, post-processed: almost no entrance window



- > Front-side illuminated (FSI) sensor
- > Photons have to traverse oxides and metals
- > Limited and non-uniform sensitivity to soft X-rays



- > Back-side illuminated (BSI) sensor bonded to carrier wafer
- > High and uniform soft X-ray sensitivity possible
- > Percival prototypes are BSI-processed at JPL (delta-doping)

# Noise vs Poisson Limit

